

STK15C88

256-Kbit (32 K × 8) PowerStore nvSRAM

Features

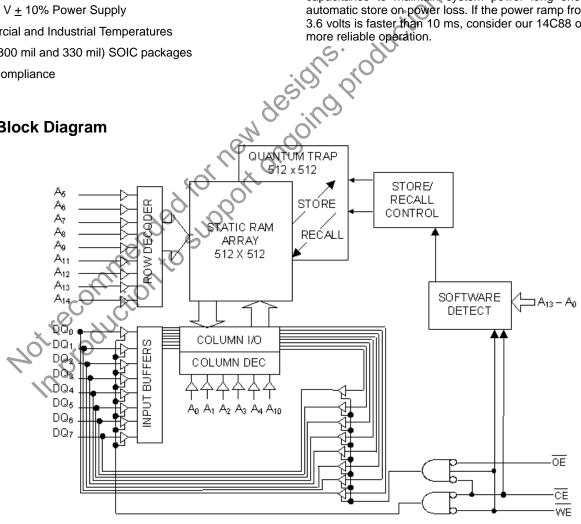
- 25 ns and 45 ns Access Times
- Pin compatible with Industry Standard SRAMs
- Automatic Nonvolatile STORE on power loss
- Nonvolatile STORE under Software Control
- Automatic RECALL to SRAM on Power Up
- Unlimited Read/Write Endurance
- Unlimited RECALL Cycles
- 1,000,000 STORE Cycles
- 100 year Data Retention
- Single 5 V ± 10% Power Supply
- Commercial and Industrial Temperatures
- 28-pin (300 mil and 330 mil) SOIC packages
- RoHS Compliance

Logic Block Diagram

Functional Description

The Cypress STK15C88 is a 256Kb fast static RAM with a nonvolatile element in each memory cell. The embedded nonvolatile elements incorporate QuantumTrap technology producing the world's most reliable nonvolatile memory. The SRAM provides unlimited read and write cycles, while independent, nonvolatile data resides in the highly reliable QuantumTrap cell. Data transfers from the SRAM to the nonvolatile elements (the STORE operation) takes place automatically at power down. On power up, data is restored to the SRAM (the RECALL operation) from the nonvolatile memory. Both the STORE and RECALL operations are also available under software control.

PowerStore nvSRAM products depend on the intrinsic system capacitance to maintain system power long enough for an automatic store on power loss. If the power ramp from 5 volts to 3.6 volts is faster than 10 ms, consider our 14C88 or 16C88 for more reliable operation.



198 Champion Court

408-943-2600 San Jose, CA 95134-1709 Revised April 10, 2011



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Pin Configurations

Figure 1. Pin Diagram - 28-pin SOIC

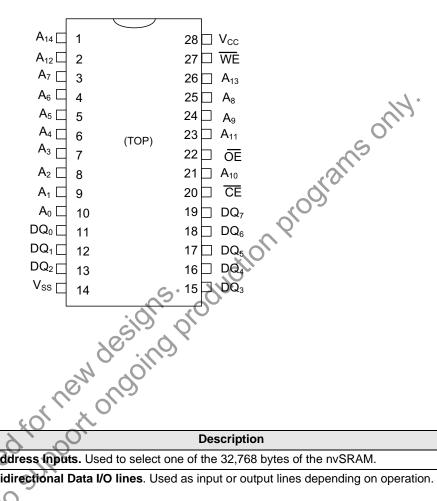


Table 1. Pin Definitions - 28-pin SOIC

Pin Name	Alt	I/O Type	Description
A ₀ -A ₁₄		Input	Address Inputs. Used to select one of the 32,768 bytes of the nvSRAM.
DQ ₀ -DQ ₇		Input or Output	Bidirectional Data I/O lines. Used as input or output lines depending on operation.
WE	W	Ingut	Write Enable Input, Active LOW. When the chip is enabled and \overline{WE} is LOW, data on the I/O pins is written to the specific address location.
CE	Ш О	Input	Chip Enable Input, Active LOW. When LOW, selects the chip. When HIGH, deselects the chip.
ŌĒ	Opi	Omput	Output Enable, Active LOW . The active LOW \overline{OE} input enables the data output buffers during read cycles. Deasserting \overline{OE} HIGH causes the I/O pins to tristate.
V _{SS}		Ground	Ground for the Device. The device is connected to ground of the system.
V _{CC}	10	Power Supply	Power Supply Inputs to the Device.



Device Operation

The STK15C88 is a versatile memory chip that provides several modes of operation. The STK15C88 can operate as a standard 32 K \times 8 SRAM. It has a 32 K \times 8 nonvolatile element shadow to which the SRAM information can be copied, or from which the SRAM can be updated in nonvolatile mode.

SRAM Read

The STK15C88 performs a READ cycle whenever \overline{CE} and \overline{OE} are LOW while WE is HIGH. The address specified on pins A₀₋₁₄ determines the 32,768 data bytes accessed. When the READ is initiated by an address transition, the outputs are valid after a delay of t_{AA} (READ cycle 1). If the READ is initiated by CE or OE, the outputs are valid at t_{ACE} or at t_{DOE}, whichever is later (READ cycle 2). The data outputs repeatedly respond to address changes within the t_{AA} access time without the need for transitions on any control input pins, and remains valid until another address change or until CE or OE is brought HIGH.

SRAM Write

A WRITE cycle is performed whenever \overline{CE} and \overline{WE} are LOW. The address inputs must be stable prior to entering the WRITE cycle and must remain stable until either \overline{CE} or \overline{WE} goes HIGH at the end of the cycle. The data on the common I/O pins DQ_{0-7} are written into the memory if it has valid t_{SD} , before the end of a \overline{WE} controlled WRITE or before the end of an \overline{CE} controlled WRITE. Keep \overline{OE} HIGH during the entire WRITE cycle to avoid data bus contention on common I/O lines. If \overline{OE} is left LOW, internal circuitry turns off the output buffers t_{HZWE} after \overline{WE} goes LOW.

AutoStore Operation

The STK15C88 uses the intrinsic system capacitance to perform an automatic STORE on power down. As long as the system power supply takes at least t_{STORE} to decay from V_{SWITCH} down to 3.6 V, the STK15C88 will safely and automatically store the SRAM data in nonvolatile elements on power down.

In order to prevent unneeded STORE operations, automatic STOREs will be ignored unless at least one WRITE operation has taken place since the most recent STORE or RECALL cycle. Software initiated STORE cycles are performed regardless of whether a WRITE operation has taken place.

Hardware RECALD (Power Up)

During power up or after any low power condition (V_{CC} < V_{RESET}), an internal RECALL request is latched. When V_{CC} once again exceeds the sense voltage of V_{SWITCH}, a RECALL cycle is automatically initiated and takes t_{HRECALL} to complete.

If the STK15C88 is in a WRITE state at the end of power up RECALL, the SRAM data is corrupted. To help avoid this situation, a 10 Kohm resistor is connected either between WE and system V_{CC} or between CE and system V_{CC}.

Software STORE

Data is transferred from the SRAM to the nonvolatile memory by a software address sequence. The STK15<u>C88</u> software STORE cycle is initiated by executing sequential CE controlled READ cycles from six specific address locations in exact order. During the STORE cycle, an erase of the previous nonvolatile data is first performed, followed by a program of the nonvolatile elements. When a STORE cycle is initiated, input and output are disabled until the cycle is completed.

Because a sequence of READs from specific addresses is used for STORE initiation, it is important that no other READ or WRITE accesses intervene in the sequence. If they intervene, the sequence is aborted and no STORE or RECALL takes place.

To initiate the software STORE cycle, the following READ sequence is performed:

- 1. Read address 0x0E38, Valid READ
- 2. Read address 0x31C7, Valid READ
- 3. Read address 0x03E0, Valid READ
- 4. Read address 0x3C1F, Valid READ
- 5. Read address 0x303F, Valid READ
- 6. Read address 0x0FC0, Initiate STORE cycle

The software sequence is clocked with \overline{CE} controlled READs. When the sixth address in the sequence is entered, the STORE cycle commences and the chip is disabled. It is important that READ cycles and not <u>WRITE</u> cycles are used in the sequence. It is not necessary that \overline{OE} is LOW for a valid sequence. After the t_{STORE} cycle time is fulfilled, the SRAM is again activated for READ and WRITE operation.

Software RECALL

Data is transferred from the nonvolatile memory to the SRAM by a software address sequence. A software RECALL cycle is initiated with a sequence of READ operations in a manner similar to the software STORE initiation. To initiate the RECALL cycle, the following sequence of CE controlled READ operations is performed:

- 1. Read address 0x0E38, Valid READ
- 2. Read address 0x31C7, Valid READ
- 3. Read address 0x03E0, Valid READ
- 4. Read address 0x3C1F, Valid READ
- 5. Read address 0x303F, Valid READ
- 6. Read address 0x0C63, Initiate RECALL cycle

Internally, RECALL is a two step procedure. First, the SRAM data is cleared, and then the nonvolatile information is transferred into the SRAM cells. After the t_{RECALL} cycle time, the SRAM is once again ready for READ and WRITE operations. The RECALL operation does not alter the data in the nonvolatile elements. The nonvolatile data can be recalled an unlimited number of times.



Hardware Protect

The STK15C88 offers hardware protection against inadvertent STORE operation and SRAM WRITEs during low voltage conditions. When $V_{CAP} < V_{SWITCH}$, all externally initiated STORE operations and SRAM WRITEs are inhibited.

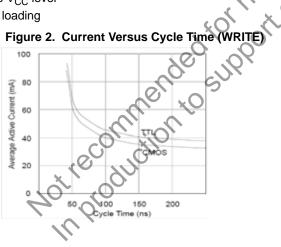
Noise Considerations

The STK15C88 is a high speed memory. It must have a high frequency bypass capacitor of approximately 0.1 µF connected between V_{CC} and V_{SS} using leads and traces that are as short as possible. As with all high speed CMOS ICs, careful routing of power, ground, and signals reduce circuit noise.

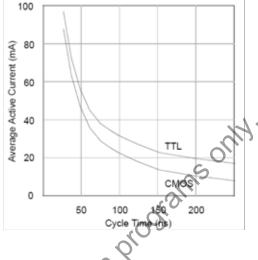
Low Average Active Power

CMOS technology provides the STK15C88 the benefit of drawing significantly less current when it is cycled at times longer than 50 ns. Figure 2 and Figure 3 show the relationship between I_{CC} and READ or WRITE cycle time. Worst case current consumption is shown for both CMOS and TTL input levels (commercial temperature range, V_{CC} = 5.5 V, 100% duty cycle on chip enable). Only standby current is drawn when the chip is disabled. The overall average current drawn by the STK15C88 depends on the following items:

- 1. The duty cycle of chip enable
- 2. The overall cycle rate for accesses
- 3. The ratio of READs to WRITEs
- 4. CMOS versus TTL input levels
- 5. The operating temperature
- 6. The V_{CC} level
- 7. I/O loading







Best Practices

nvSRAM products have been used effectively for over 15 years. While ease-of-use is one of the product's main system values. experience gained working with hundreds of applications has resulted in the following suggestions as best practices:

- The nonvolatile cells in an nvSRAM are programmed on the test floor during final test and quality assurance. Incoming inspection routines at customer or contract manufacturer's sites, sometimes, reprogram these values. Final NV patterns are typically repeating patterns of AA, 55, 00, FF, A5, or 5A. End product's firmware should not assume a NV array is in a set programmed state. Routines that check memory content values to determine first time system configuration and cold or warm boot status should always program a unique NV pattern (for example, complex 4-byte pattern of 46 E6 49 53 hex or more random bytes) as part of the final system manufacturing test to ensure these system routines work consistently.
- Power up boot firmware routines should rewrite the nvSRAM into the desired state. While the nvSRAM is shipped in a preset state, best practice is to again rewrite the nvSRAM into the desired state as a safeguard against events that might flip the bit inadvertently (program bugs and incoming inspection routines).



Table 2. Software STORE/RECALL Mode Selection

CE	WE	A ₁₃ – A ₀	Mode	I/O	Notes
L	Н	0x0E38 0x31C7 0x03E0 0x3C1F 0x303F 0x0FC0	Read SRAM Read SRAM Read SRAM Read SRAM Read SRAM Nonvolatile STORE	Output Data Output Data Output Data Output Data Output Data Output Data Output Data	[1, 2]
L	Н	0x0E38 0x31C7 0x03E0 0x3C1F 0x303F 0x0C63	Read SRAM Read SRAM Read SRAM Read SRAM Read SRAM Nonvolatile RECALL	Output Data Output Data Output Data Output Data Output Data Output Data	ortW ^[1, 2]
Not	ecommende production	d for new de	Read SRAM Read SRAM Read SRAM Nonvolatile RECALL	on proof	

Notes

The six consecutive addresses must be in the order listed. WE must be high during all six consecutive CE controlled cycles to enable a nonvolatile cycle.
 While there are 15 addresses on the STK15C88, only the lower 14 are used to control software modes.



Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. These user guidelines are not tested.

Storage Temperature65 °C to +150 °C
Temperature under bias55 °C to +125 °C
Supply Voltage on V_CC Relative to GND–0.5 V to 7.0 V
Voltage on Input Relative to Vss–0.6 V to V _{CC} + 0.5 V

DC Electrical Characteristics

Voltage on DQ ₀₋₇	–0.5 V to Vcc + 0.5 V
Power Dissipation .	

DC output Current (1 output at a time, 1s duration) 15 mA

Operating Range

Range	Range Ambient Temperature V _{CC}	
Commercial	0 °C to +70 °C	4.5 V to 5.5 V
Industrial	–40 °C to +85 °C	4.5 V to 5.5 V

			industriai	-40 C 10 +65 C	4.5	10 5.5	v
DC Elect	on	Ά.					
Parameter	ameter Description Test Conditions						Unit
I _{CC1}	Average V _{CC} Current	t _{RC} = 45 ns		Commercial	_	97 70	mA mA
		Dependent on output loading ar obtained without output loads. $I_{OUT} = 0$ mA.	nd cycle rate. Val	ues Industrial	-	100 70	mA mA
I _{CC2}	Average V _{CC} Current during STORE	All Inputs Do Not Care, $V_{CC} = M$ Average current for duration t_{ST}		c ^{il0}	-	3	mA
I _{CC3}	Average V _{CC} Current at t _{RC} = 200 ns, 5V, 25°C Typical	$\overline{\text{WE}} \ge (\text{V}_{\text{CC}} - 0.2\text{V})$. All other inp Dependent on output loading ar output loads.	outs cycling. nd cycle rate. Val	ues obtained without	_	10	mA
I _{CC4}	Average Current during AutoStore Cycle	All Inputs Do Not Care, V _{CC} A Average current for duration t _{ST}	II Inputs Do Not Care, V _{CC} Anax verage current for duration t _{STORE}				mA
I _{SB1} ^[3]	Average V _{CC} Current (Standby, Cycling	$t_{RC} = 25ns, \overline{CE} \ge V_{H}$ $t_{RC} = 45ns, \overline{CE} \ge V_{H}$)	Commercial	-	30 22	mA
	TTL Input Levels)	for the		Industrial	_	31 23	mA
I _{SB2} ^[3]	V _{CC} Standby Current (Standby, Stable CMOS Input Levels)	$\overline{CE} \ge (V_{OC} - 0.2 \text{ V})$. All others V	/ _{IN} ≤ 0.2 V or ≥ ([\]	/ _{CC} – 0.2 V).	_	1.5	mA
I _{IX}	Input Leakage Current	$V_{CC} = Max, V_{SS} \le V_{IN} \le V_{CC}$			-1	+1	μA
I _{OZ}	Off State Output Leakage Current	$V_{CC} = Max, V_{SS} \le V_{IN} \le V_{CC}, \overline{C}$	E or OE ≥ V _{IH} or	$\overline{\text{WE}} \leq \text{V}_{\text{IL}}$	-5	+5	μΑ
V _{IH}	Input HIGH Voltage				2.2	V _{CC} + 0.5	V
V _{IL}	Input LOW Voltage				V _{SS} – 0.5	0.8	V
V _{OH}	Output HIGH Voltage	I _{OUT} = -4 mA			2.4	_	V
V _{OL}	Output LOW Voltage	I _{OUT} = 8 mA			-	0.4	V

Note 3. $\overline{CE} \ge V_{IH}$ will not produce standby current levels until any nonvolatile cycle in progress has timed out.



Data Retention and Endurance

Parameter	Description	Min	Unit
DATA _R	Data Retention	100	Years
NV _C	Nonvolatile STORE Operations	1,000	K

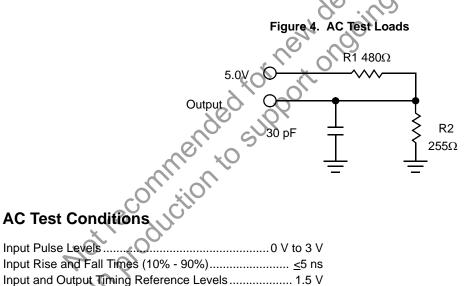
Capacitance

In the following table, the capacitance parameters are listed.^[4]

In the following table, the capacitance parameters are listed. ^[4]						
Parameter	Description	Test Conditions	Max	Unit		
C _{IN}	Input Capacitance	$T_A = 25 ^{\circ}C, f = 1 \text{MHz},$	5	рF		
C _{OUT}	Output Capacitance	$V_{CC} = 0$ to 3.0 V	7	pF		

Thermal Resistance

C _{OUT}	Output Capacitanc	ve vec = 0 10 3.0 v		7	pl	-	
Thermal Resistance In the following table, the thermal resistance parameters are listed. ^[4]							
Parameter	Description	Test Conditions	<u>j</u> 01	28-pin SOIC (300 mil)	28-pin SOIC (330 mil)	Unit	
Θ_{JA}	Thermal Resistance (Junction to Ambient)	Test conditions follow standard test method procedures for measuring thermal impedar		TBD	TBD	°C/W	
Θ _{JC}	Thermal Resistance (Junction to Case)	per EIA / JESD51.		TBD	TBD	°C/W	



Note

4. These parameters are guaranteed by design and are not tested.

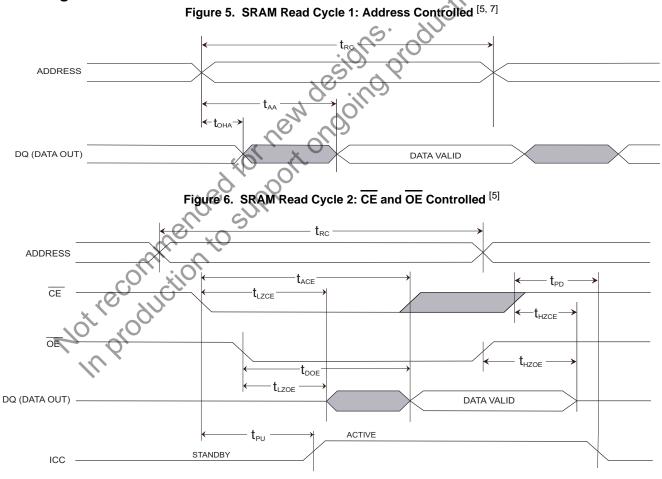


AC Switching Characteristics

SRAM Read Cycle

Parameter			25	ns	45 ns		
Cypress Parameter	Alt	Description	Min	Max	Min	Max	Unit
t _{ACE}	t _{ELQV}	Chip Enable Access Time	-	25	-	45	ns
t _{RC} ^[5]	t _{AVAV} , t _{ELEH}	Read Cycle Time	25	-	45	-	ns
t _{AA} ^[6]	t _{AVQV}	Address Access Time	-	25	-	45	ns
t _{DOE}	t _{GLQV}	Output Enable to Data Valid	-	10	-	20	ns
t _{OHA} ^[6]	t _{AXQX}	Output Hold After Address Change	5	-	5 🕻	<u> </u>	ns
t _{LZCE} ^[7]	t _{ELQX}	Chip Enable to Output Active	5	-	5	_	ns
t _{HZCE} ^[7]	t _{EHQZ}	Chip Disable to Output Inactive	-	10	6	15	ns
t _{LZOE} ^[7]	t _{GLQX}	Output Enable to Output Active	0		0	_	ns
t _{HZOE} ^[7]	t _{GHQZ}	Output Disable to Output Inactive	-	10	-	15	ns
t _{PU} ^[4]	t _{ELICCH}	Chip Enable to Power Active	0	205	0	-	ns
t _{PD} ^[4]	t _{EHICCL}	Chip Disable to Power Standby		Q 25	—	45	ns

Switching Waveforms



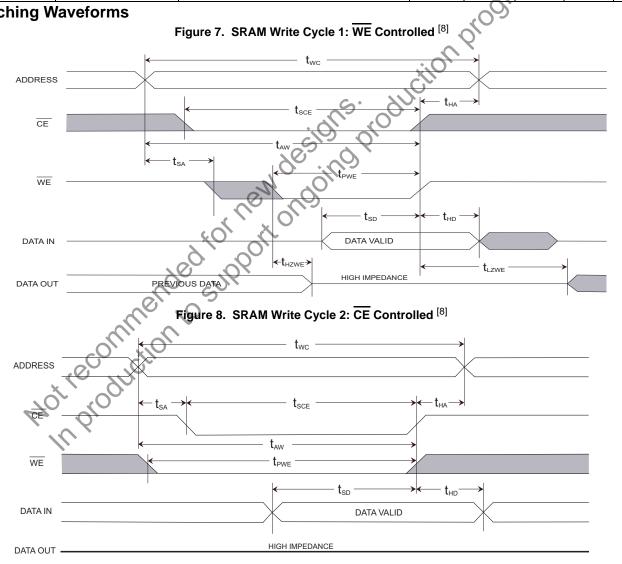
- $\begin{array}{l} \textbf{Notes} \\ \textbf{5. WE must be HIGH } \underline{during SRAM Read Cycles and LOW during SRAM WRITE cycles.} \\ \textbf{6. I/O state assumes CE and OE } v_{IL} and WE \geq v_{IH}; device is continuously selected.} \\ \textbf{7. Measured } \pm 200 \text{ mV from steady state output voltage.} \end{array}$



SRAM Write Cycle

Parameter			25 ns		45 ns		
Cypress Parameter	Alt	Description	Min	Max	Min	Max	Unit
t _{WC}	t _{AVAV}	Write Cycle Time	25		45		ns
t _{PWE}	t _{WLWH} , t _{WLEH}	Write Pulse Width	20		30		ns
t _{SCE}	t _{ELWH} , t _{ELEH}	Chip Enable To End of Write	20		30		ns
t _{SD}	t _{DVWH} , t _{DVEH}	Data Setup to End of Write	10		15		ns
t _{HD}	t _{WHDX} , t _{EHDX}	Data Hold After End of Write	0		0		ns
t _{AW}	t _{AVWH} , t _{AVEH}	Address Setup to End of Write	20		30	2	ns
t _{SA}	t _{AVWL} , t _{AVEL}	Address Setup to Start of Write	0		0 (ns
t _{HA}	t _{WHAX} , t _{EHAX}	Address Hold After End of Write	0		0		ns
t _{HZWE} ^[7,8]	t _{WLQZ}	Write Enable to Output Disable		10		15	ns
t _{LZWE} ^[7]	t _{WHQX}	Output Active After End of Write	5		5		ns

Switching Waveforms

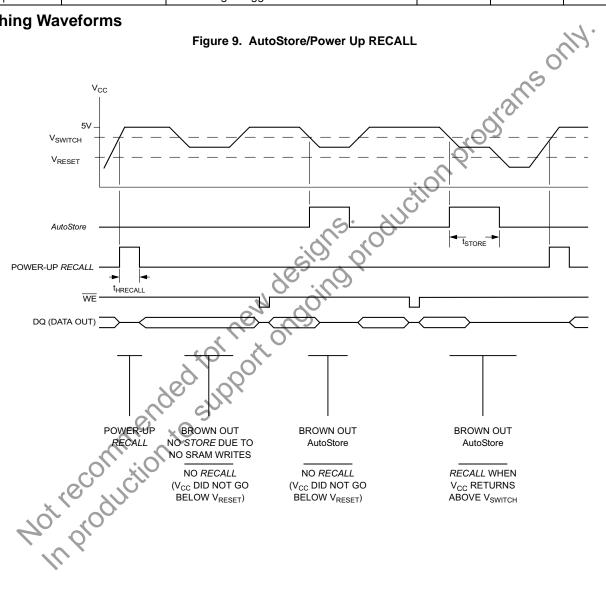




AutoStore or Power Up RECALL

Parameter	Alt	Description	STK1	5C88	Unit	
Farameter	All	Description	Min	Max	Onit	
t _{HRECALL} ^[10]	t _{RESTORE}	Power up RECALL Duration		550	μS	
t _{STORE} [6]	t _{HLHZ}	STORE Cycle Duration		10	ms	
V _{RESET}		Low Voltage Reset Level		3.6	V	
V _{SWITCH}		Low Voltage Trigger Level	4.0	4.5	V	

Switching Waveforms



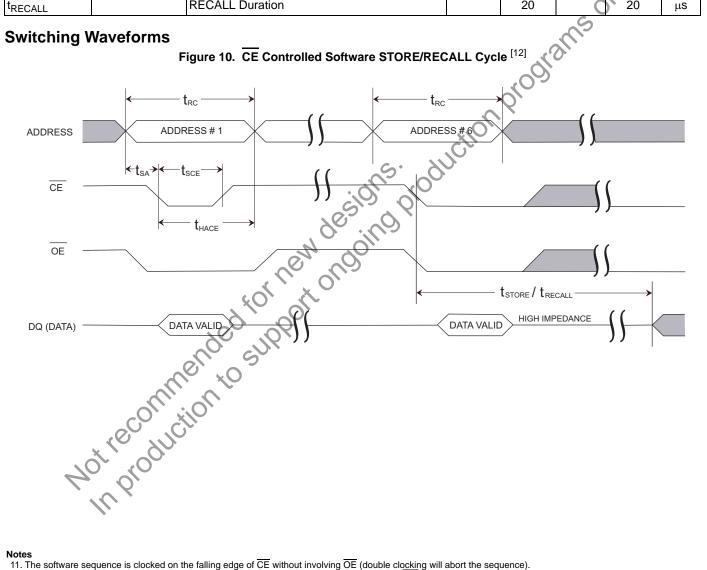


Software Controlled STORE/RECALL Cycle

The software controlled STORE/RECALL cycle follows. [11, 12]

Parameter	Alt	Description	25 ns		45 ns		Unit
Parameter	AIL	Description	Min	Max	Min	Max	Unit
t _{RC}	t _{AVAV}	STORE/RECALL Initiation Cycle Time	25		45		ns
t _{SA} ^[11]	t _{AVEL}	Address Setup Time	0		0		ns
t _{CW} ^[11]	t _{ELEH}	Clock Pulse Width	20		30	.	ns
t _{HACE} [7, 11]	t _{ELAX}	Address Hold Time	20		20	77	ns
t _{RECALL}		RECALL Duration		20	C	20	μS

Switching Waveforms



Notes

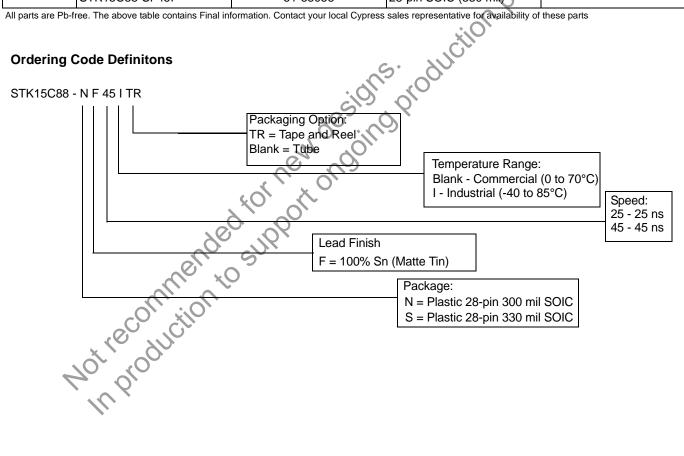
The software sequence is clocked on the falling edge of CE without involving OE (double clocking will abort the sequence).
 The six consecutive addresses must be read in the order listed in the Mode Selection table. WE must be HIGH during all six consecutive cycles.



Ordering Information

These parts are not recommended for new designs. They are in production to support ongoing production programs only.

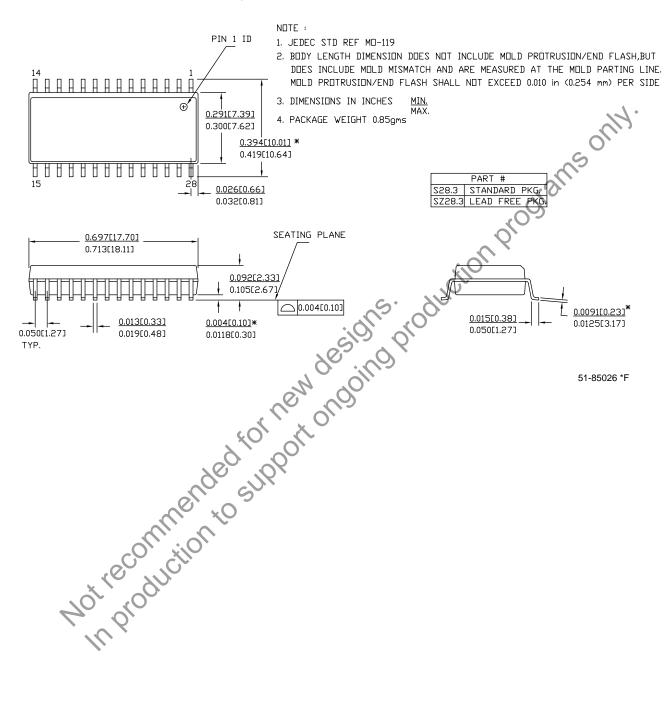
Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
25	STK15C88-NF25ITR	51-85026	28-pin SOIC (300 mil)	Industrial
	STK15C88-NF25I	51-85026	28-pin SOIC (300 mil)	
	STK15C88-SF25ITR	51-85058	28-pin SOIC (330 mil)	1.
	STK15C88-SF25I	51-85058	28-pin SOIC (330 mil)	
45	STK15C88-NF45TR	51-85026	28-pin SOIC (300 mil)	Commercial
	STK15C88-NF45	51-85026	28-pin SOIC (300 mil)	S
	STK15C88-NF45ITR	51-85026	28-pin SOIC (300 mil)	Industrial
	STK15C88-NF45I	51-85026	28-pin SOIC (300 mil)	K.o.
	STK15C88-SF45ITR	51-85058	28-pin SOIC (330 mil)	Ð
	STK15C88-SF45I	51-85058	28-pin SOIC (330 mil)	





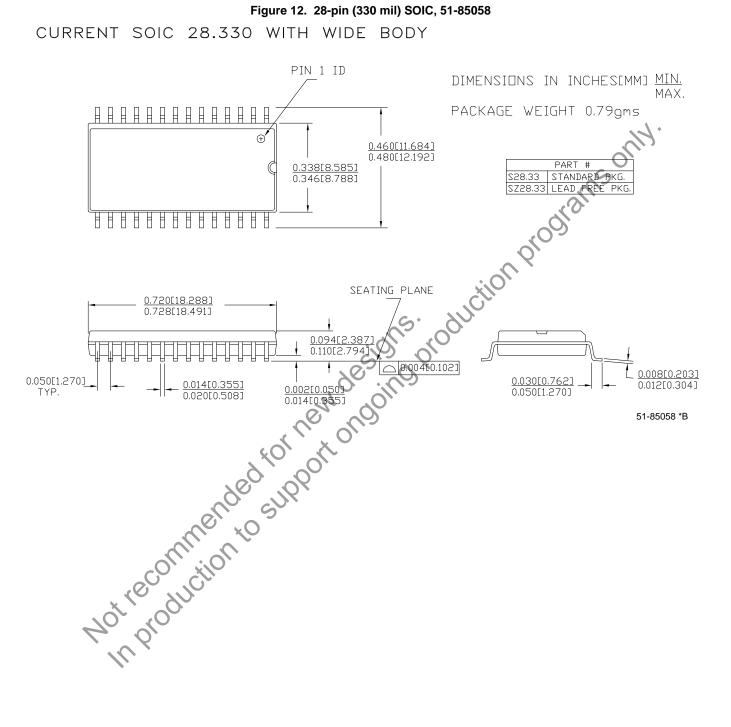
Package Diagrams

Figure 11. 28-pin (300 mil) SOIC, 51-85026





Package Diagrams (continued)





Document History Page

Rev.	ECN No.	Orig. of Change	Submission Date	Description of Change
**	2625096	GVCH/PYRS	12/19/08	New data sheet
*A	2826441	GVCH	12/11/2009	Added following text in the Ordering Information section: "These parts are not recommended for new designs. In production to support ongoing pro- duction programs only." Added watermark in PDF stating "Not recommended for new designs. In production to support ongoing production programs only." Added Contents on page 2.
*В	3052511	GVCH	10/08/10	Removed the following inactive parts from the Ordering Information table STK15C88-NF25, STK15C88-NF25TR, STK15C88-SF25, STK15C88-SF25TR, STK15C88-SF45, STK15C88-SF45TR Updated package diagrams
*C	3221180	GVCH	04/10/2011	Updated Package Diagrams. Updated in new template.
			, C	Updated package diagrams. Updated Package Diagrams. Updated in new template.



Sales, Solutions and Legal Information

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	cypress.com/go/plc	O.
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PSoC	cypress.com/go/psoc	
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USB Controllers	cypress.com/go/USB	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~
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